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An organic light emitting diode (OLED) display includes a lower substrate having a display area displaying an image and a non-display area formed along an edge of the display area, the display area having a first thickness, at least a part of the non-display area having a second thickness that is greater than the first thickness; and a protection member disposed at the lower side of the lower substrate, the protection member being disposed in the display area of the lower substrate.

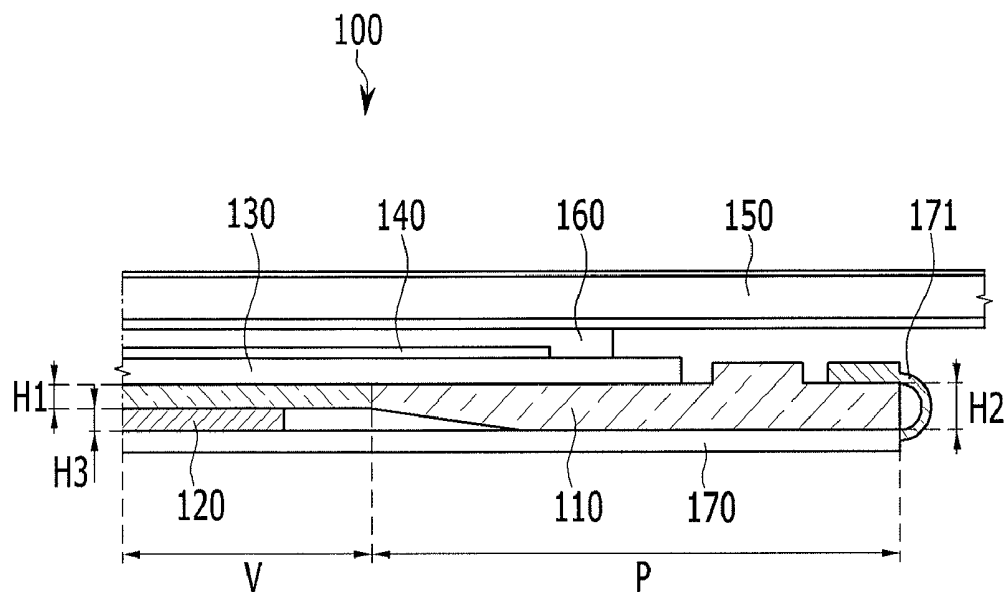


FIG. 1

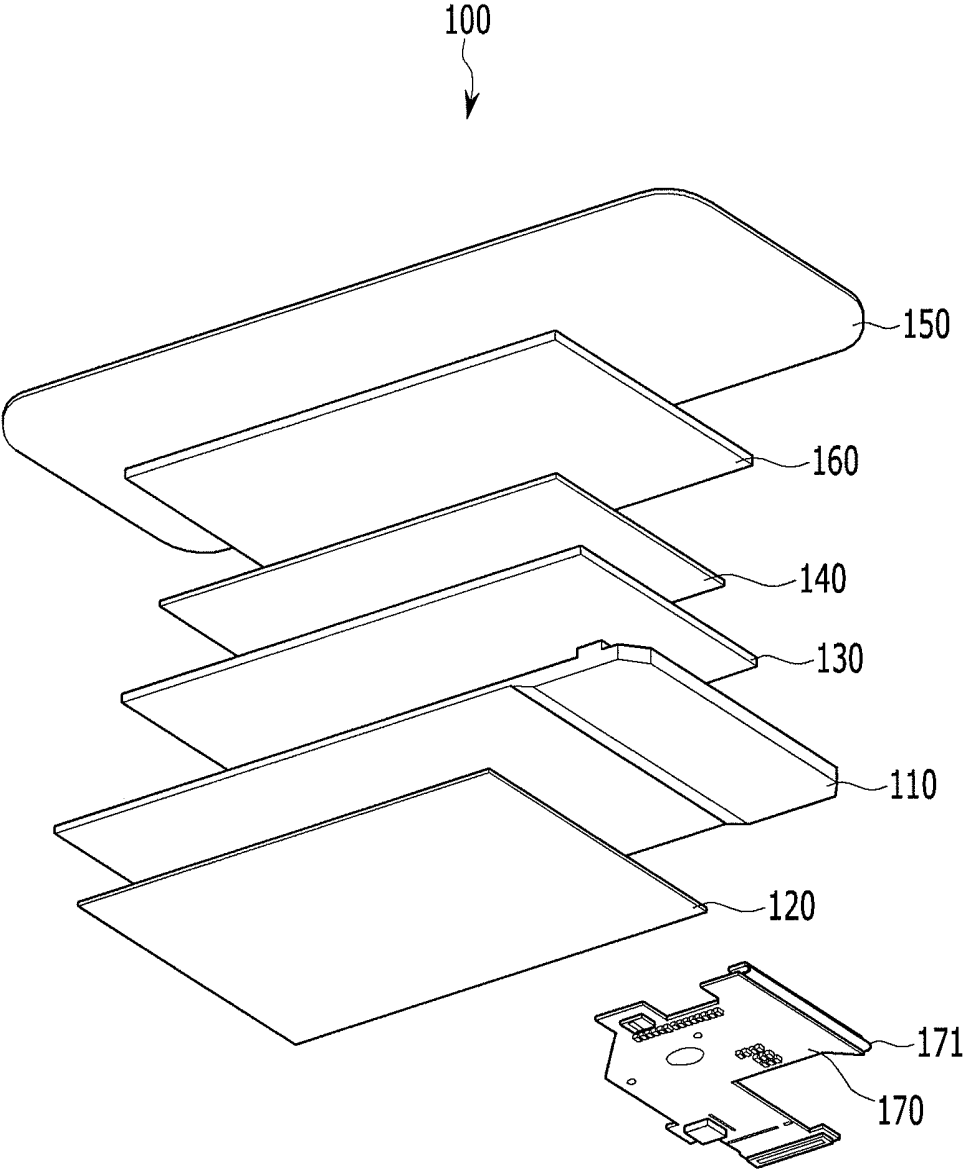


FIG. 2

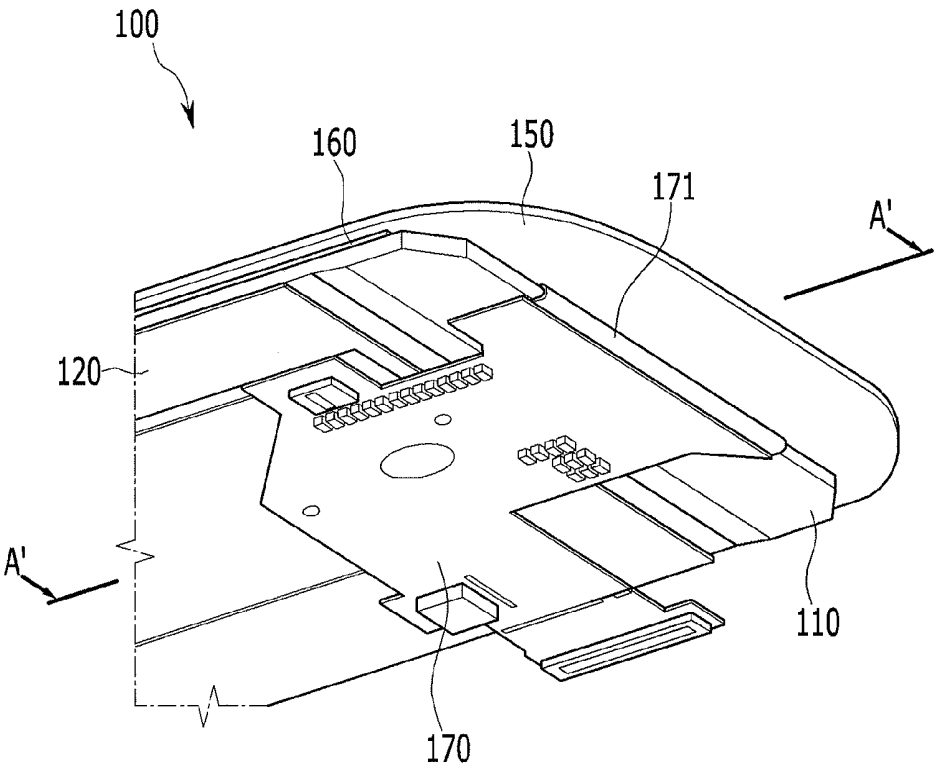


FIG. 3

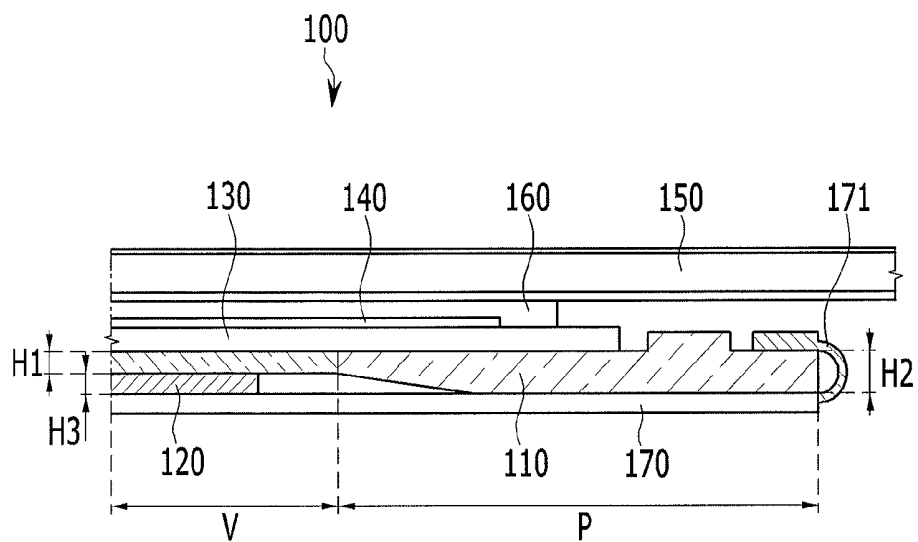


FIG. 4

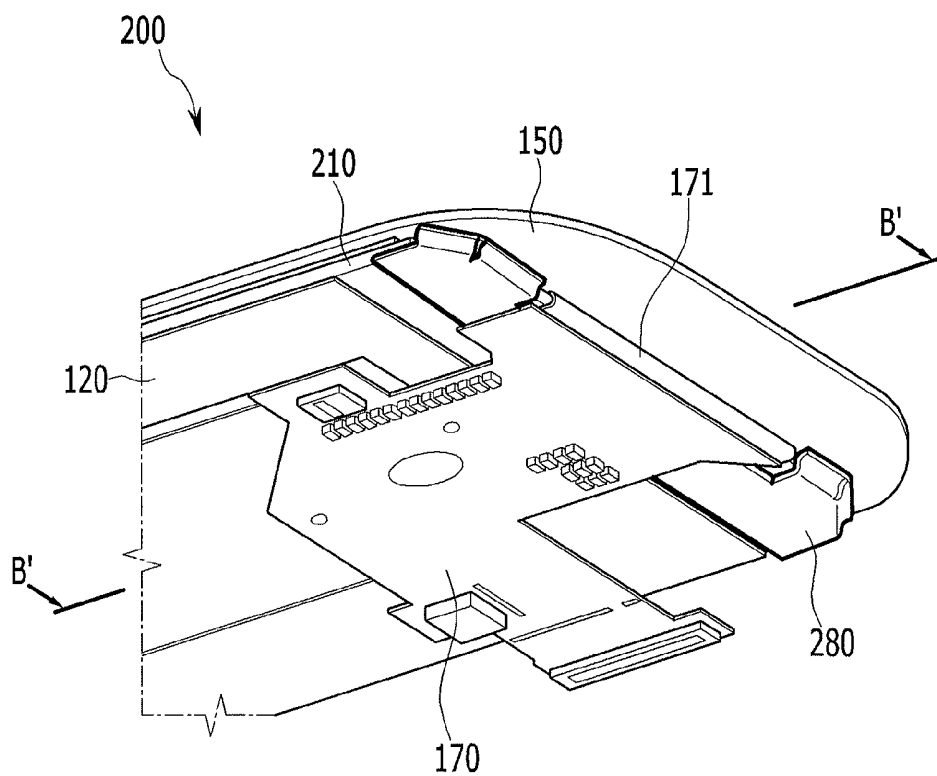
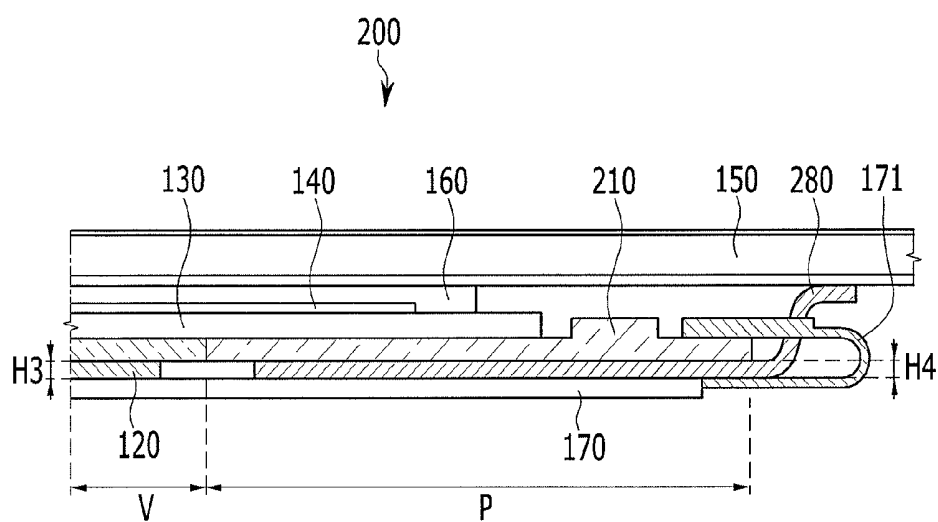


FIG. 5



ORGANIC LIGHT EMITTING DIODE DISPLAY

CROSS-REFERENCE TO RELATED APPLICATION

[0001] This application claims priority to and the benefit of Korean Patent Application No. 10-2013-0024699, filed in the Korean Intellectual Property Office on Mar. 7, 2013, the entire contents of which are incorporated herein by reference.

BACKGROUND

[0002] 1. Field

[0003] Embodiments relate to an organic light emitting diode (OLED) display.

[0004] 2. Description of the Related Art

[0005] An organic light emitting diode display may include organic light emitting elements constituted by a hole injection electrode, an organic emission layer, and an electron injection electrode. The organic light emitting element may emit light by energy generated when an exciton generated by combining an electron and a hole in the organic emission layer falls from an excited state to a lower state, and the organic light emitting diode display may display a predetermined image by using this light emission. An organic light emitting diode display may have a self-luminance characteristic such that a separate light source is not required, unlike a liquid crystal display. Thus, a thickness and a weight of the organic light emitting diode display may be reduced. Further, since the organic light emitting diode display may exhibit desirable characteristics such as low power consumption, high luminance, and rapid response speed, the organic light emitting diode display is of interest as a next generation display.

[0006] The above information disclosed in this Background section is only for enhancement of understanding of the background of the invention and therefore it may contain information that does not form the prior art that is already known in this country to a person of ordinary skill in the art.

SUMMARY

[0007] Embodiments are directed to an organic light emitting diode (OLED) display, including a lower substrate having a display area displaying an image and a non-display area formed along an edge of the display area, the display area having a first thickness, at least a part of the non-display area having a second thickness that is greater than the first thickness; and a protection member disposed at the lower side of the lower substrate, the protection member being disposed in the display area of the lower substrate.

[0008] In the lower side of the lower substrate, the lower substrate may have an inclined or curved interface between a portion formed with the first thickness and a portion formed with the second thickness.

[0009] One end of the protection member may be adjacent to a portion where the inclination or the curve starts in the interface.

[0010] The protection member may have a size that is equal to or smaller than the display area of the lower substrate.

[0011] The protection member may have a third thickness, and the sum of the first thickness and the third thickness may be equal to or greater than the second thickness.

[0012] Embodiments are also directed to an organic light emitting diode (OLED) display, including a window; a lower substrate disposed at a lower side of the window, and includ-

ing a display area and a non-display area; a protection member disposed in the display area of the lower substrate; and a reinforcement member disposed in the shape of a plate and disposed at a lower side of the lower substrate, the reinforcement member supporting a portion of the lower substrate that corresponds to the non-display area.

[0013] The protection member may have a size that is equal to or smaller than the display area of the lower substrate.

[0014] The protection member may have a third thickness, the reinforcement member may have a fourth thickness, and the third thickness may be equal to or greater than the fourth thickness.

[0015] The reinforcement member may be made of an aluminum alloy or stainless steel.

[0016] The reinforcement member may be extended to support the lower side of the window.

BRIEF DESCRIPTION OF THE DRAWINGS

[0017] Features will become apparent to those of skill in the art by describing in detail example embodiments with reference to the attached drawings in which:

[0018] FIG. 1 is an exploded perspective view of an OLED display according to an example embodiment.

[0019] FIG. 2 is a perspective view of a part of the OLED display shown in FIG. 1.

[0020] FIG. 3 is cross-sectional view of the OLED display of FIG. 2, taken along the line A-A'.

[0021] FIG. 4 is a perspective view partially illustrating an OLED display according to another example embodiment.

[0022] FIG. 5 is a cross-sectional view of the OLED display of FIG. 4, taken along the line B-B'.

DETAILED DESCRIPTION

[0023] Example embodiments will now be described more fully hereinafter with reference to the accompanying drawings; however, they may be embodied in different forms and should not be construed as limited to the embodiments set forth herein. Rather, these embodiments are provided so that this disclosure will be thorough and complete, and will fully convey the scope of the example embodiments to those skilled in the art. In the drawing figures, dimensions may be exaggerated for clarity of illustration. Like reference numerals refer to like elements throughout.

[0024] Throughout this specification and the claims that follow, when it is described that an element is "coupled" to another element, the element may be "directly coupled" to the other element or "electrically coupled" to the other element through a third element. In addition, unless explicitly described to the contrary, the word "comprise" and variations such as "comprises" or "comprising", will be understood to imply the inclusion of stated elements but not the exclusion of any other elements.

[0025] An entire structure of an organic light emitting diode (OLED) display according to an example embodiment will now be described.

[0026] FIG. 1 is an exploded perspective view of an OLED display according to an example embodiment, FIG. 2 is a perspective view of a part of the OLED display according to the example embodiment of FIG. 1, and FIG. 3 is a cross-sectional view of the OLED display of FIG. 2, taken along the line A-A'.

[0027] Referring to FIG. 1 to FIG. 3, an OLED display 100 according to the example embodiment may include a lower

substrate **110**, a protection member **120**, an upper substrate **130**, a plurality of organic light emitting elements (not shown), a polarizer **140**, a window **150**, an adhesive layer **160**, and a main board **170**.

[0028] In the present example embodiment, the lower substrate **110** includes a display area V and a non-display area P. The display area V outputs an image. The non-display area P is formed along the edges of the display area V. The plurality of pixels may be arranged in a matrix format in the display area V. A scan driver (not shown) and a data driver (not shown) may be provided between the display area A and a sealant (not shown) or in an external side of the sealant in order to drive pixels.

[0029] In addition, pad electrodes (not shown) may be provided in the display area V of the lower substrate **110** to transmit electric signals to the scan driver and the data driver.

[0030] When the OLED display **100** according to the example embodiment is a low temperature polycrystalline silicon (LTPS) type OLED display, the lower substrate **110** may be formed as a LTPS glass.

[0031] In the present example embodiment, the protection member **120** is disposed in a lower side of the lower substrate **110**. The protection member **120** prevents external impact from being transmitted to the lower substrate **110**. The protection member **120** may be disposed in the display area V in the lower substrate **110**. Such a protection member **120** may be made of a sponge material. On the other hand, the protection member **120** may be formed of a black tape.

[0032] The upper substrate **130** may be disposed on the lower substrate **110**. The upper substrate **130** may be bonded to the lower substrate **110** by the sealant while forming a predetermined gap therebetween. The upper substrate **130** encapsulates driving circuits (not shown) and organic light emitting elements (not shown) formed at the lower substrate **110**. The upper substrate **130** may be made of various materials including glass or plastic.

[0033] In the present example embodiment, the main board **170** is disposed at a lower side of the protection member **120**. A flexible printed circuit film **171** may be disposed at one side of the main board **170**. The flexible printed circuit film **171** may be installed on the lower substrate **110** by a chip on glass (COG) method. The main board **170** transmits a control signal to the organic light emitting elements formed with a pattern on the lower substrate **110**.

[0034] The plurality of organic light emitting elements (not shown) are disposed between the lower substrate **110** and the upper substrate **130**, and may be formed in the display area V of the lower substrate **110**.

[0035] The polarizer **140** may be disposed on the upper substrate **130**. The polarizer **140** aligns a direction of light passing therethrough.

[0036] The window **150** may be disposed on the polarizer **140**. The window **150** may be formed of glass or acrylic having excellent light transmitting characteristic. The window **150** enables an image output by the organic light emitting elements to be displayed to the outside.

[0037] The adhesive layer **160** is disposed between the polarizer **140** and the window **150**. The adhesive layer **160** may be, for example, an optically clear adhesive (OCA).

[0038] The upper substrate **130**, the plurality of organic light emitting elements, the polarizer **140**, the window **150**, and the adhesive layer **160** may be the same as those in a general OLED display.

[0039] In the OLED display **100** having a structure according to the present example embodiment, the protection member **120** may be disposed in the display area V in the lower substrate **110**. Thus, the protection member **120** may be disposed in the display area V and may not be disposed in the non-display area P. In further detail, the protection member **120** may be the same as the display area V of the lower substrate **110** or smaller than the display area V in size. In an implementation, the display area V of the lower substrate **110** has a first thickness H1, and at least a part of the non-display area P of the lower substrate **110** has a second thickness H2 that is greater than (thicker) than the first thickness H1.

[0040] As described above, the structure in which the protection member **120** is disposed only in the display area V enables the entire thickness of the OLED display **100** to be reduced as much as the thickness of the protection member **120** compared to a structure in which the protection member **120** is disposed not only in the display area V but also in the non-display area P.

[0041] Further, since the non-display area P where the protection member **120** is not disposed is relatively thicker than the display area V where the protection member **120** is formed, the strength of a portion that corresponds to the non-display area P in the lower substrate **110** may be improved. Thus, in the OLED display **100** according to the present example embodiment, the OLED display **100** may be made slim by reducing the entire thickness thereof while improving impact resistance by improving strength of the lower substrate **110**.

[0042] In the lower substrate **110**, the display area V may have the first thickness H1 and the thickness of the non-display area P may have the second thickness when the OLED display **100** is manufactured using, for example, an etching process. During a manufacturing process of the OLED display according to the present example embodiment, the etching process may be used. The thickness of the display area V and the thickness of the non-display area P may be formed to be different from each other by increasing the etching time for the display area V to be longer than the etching time for the non-display area P. However, the method for differentiating the thickness of the display area and the non-display area in the lower substrate is not limited to the etching method.

[0043] The interface of the portion formed with the first thickness H1 and the portion formed with the second thickness H2 in the lower side of the lower substrate **110** may be inclined. In another implementation, the interface of the portion formed with the first thickness H1 and the portion formed with the second thickness H2 in the lower side of the lower substrate **110** may be curved.

[0044] With such a structure, when the external impact is applied to the OLED display **100** according to the example embodiment, resistance to a stress generated in the interface of the portion formed with the first thickness H1 and the portion formed with the second thickness H2 in the lower side of the lower substrate **110** may be improved, thereby helping to prevent damage to the lower substrate **110**.

[0045] Further, when the interface of the portion formed with the first thickness H1 and the portion formed with the second thickness H2 in the lower side of the lower substrate **110** is inclined or curved, the protection member **120** may be disposed to be adjacent to a portion where the inclination or the curve starts in the interface at one side thereof.

[0046] The protection member **120** may have a third thickness H3, and the sum of the first thickness H1 and the third thickness H3 may be equivalent to or greater than the second thickness H2.

[0047] On the other hand, if the sum of the first thickness H1 and the third thickness H3 is smaller than the second thickness H2, the main board **170** may not be tightly bonded to the protection member **120**, thereby generating a gap therebetween. Thus, the impact transmitted to the main board **170** may be directly transmitted to the lower substrate **110** so that the lower substrate **110** may be damaged.

[0048] However, according to the present example embodiment, the sum of the first thickness H1 and the third thickness H3 is equivalent to or greater than the second thickness H2 so that the main board **170** may be tightly bonded to the protection member **120**. Accordingly, when the impact is transmitted to the main board **170**, the impact may not be directly transmitted to the lower substrate **110**, thereby helping to prevent the lower substrate **110** from being damaged.

[0049] FIG. 4 is a perspective view that partially illustrates an OLED display according to another example embodiment, and FIG. 5 is a cross-sectional view of the OLED display of FIG. 4, taken along the line B-B'.

[0050] Referring to FIG. 4 and referring to FIG. 5, an OLED display **200** according to the present example embodiment includes the window **150**, the lower substrate **210**, the protection member **120**, the upper substrate **130**, the plurality of organic light emitting elements, the polarizer **140**, the adhesive layer **160**, and a reinforcing member **280**.

[0051] Here, the protection member **120**, the window **150**, the upper substrate **130**, the plurality of organic light emitting elements (not shown), the polarizer **140** and the adhesive layer **160** are described in the previous example embodiment.

[0052] The lower substrate **210** is disposed at a lower side of the window **150**, and includes a display area V and a non-display area P. Unlike the OLED display **100** (refer to FIG. 2) of the previous example embodiment, the display area V and the non-display area P of the lower substrate **210** included in the OLED display **200** according to the present example embodiment have the same thickness.

[0053] The reinforcing member **280** is formed in the shape of a plate and supports a portion that corresponds to the non-display area P at the lower side of the lower substrate **210**. The reinforcing member **280** may be made of a metal. The reinforcing member **280** may be made of an aluminum alloy or stainless steel.

[0054] Such a reinforcing member **280** may be manufactured individually from the lower substrate **210** and then may be coupled to the lower substrate **210** or the window **150**. On the other hand, the reinforcing member **280** may be made of plastic, and may be formed by injection molding.

[0055] The entire thickness of the OLED display **200** may be reduced as much as the thickness of the protection member **120**, not with a structure in which the protection member **280** is disposed in the display area V as well as in the non-display area P, but with a structure in which the protection member **280** is disposed only in the display area V.

[0056] In addition, the OLED display **100** according to the previous example embodiment uses a process for forming the non-display area P to be thick in the lower substrate **110** (refer to FIG. 2). However, the OLED display **200** according to the present example embodiment may be manufactured without having a process for individually processing the areas of the

lower substrate **210**. Accordingly, a manufacturing cost in manufacturing of the OLED display **200** may be reduced.

[0057] Further, the lower substrate **210** in the OLED display **200** according to the present example embodiment may be formed of glass or a transparent film. In the OLED display **200** according to the present example embodiment, the reinforcement member **280** that is relatively stronger than glass or a film is disposed in the lower side of the lower substrate **210** so that impact resistance may be further significantly improved compared to a general OLED display that does not include such a reinforcement member.

[0058] Thus, the entire thickness of the OLED display **200** according to the present example embodiment may be slim, and at the same time the reinforcement member **280** may improve strength of the lower substrate **210** so that resistance with respect to external impact may be significantly improved.

[0059] One side of the reinforcing member **280** may be extended to support the lower side of the window **150**. In further detail, one side of the reinforcement member **280** may be extended from the circumference thereof, disposed adjacent to the external edge of the lower substrate **110** so as to contact the lower side of the window **150**. With such a structure, external force transmitted to the reinforcement member **280** may be dispersed to the window **150** and the protection member **120**, and accordingly the external force may be prevented from being transmitted to the lower substrate **210**, thereby helping prevent the lower substrate **210** from being damaged due to the external force.

[0060] The protection member **120** may have a third thickness H3 and the reinforcing member **280** may have a fourth thickness H4. In this case, the third thickness may be equal to or greater than the fourth thickness. If the fourth thickness H4 of the reinforcing member **280** is greater than the third thickness H3 of the protection member **120**, the entire thickness of the OLED display **200** may be increased.

[0061] In the OLED display **200** according to the present example embodiment, the thickness of the reinforcing member **280** is equal to or smaller than the thickness of the protection member **120** so that the OLED display **200** may be made slim. Particularly, when the fourth thickness H4 of the reinforcing member **280** is equal to the third thickness H3 of protection member **120**, the upper side of the main board **170** may be wholly bonded to the reinforcing member **280** and the protection member **120** so that external impact transmitted to the main board **170** may be dispersed to the reinforcing member **280** and the protection member **120**, thereby helping to prevent the OLED display **200** from being damaged.

[0062] By way of summation and review, mobile devices are being made increasingly thin, and thus an OLED display mounted to a mobile device should be thin. A panel assembly included in such an OLED display may be formed of two thin substrates. Unlike a liquid crystal display, in which a panel assembly may be filled with liquid crystal, the panel assembly of the OLED display may have therein an empty space, which may make the panel assembly relatively weak against impacts from being dropped. Therefore, making the OLED display slim only by reducing the thickness of members forming the panel assembly thereof may result in weakness.

[0063] As described above, embodiments may provide an organic light emitting diode (OLED) display that may be made slim while having improved impact resistance. According to an embodiment, a protection member is disposed on a display area of the display member so that the entire thickness

of the OLED display may be reduced as much as the thickness of the protection member, compared to a structure in which the protection member is disposed not only in the display area but also in the non-display area. Further, the non-display area where the protection member is not disposed may be relatively thicker than the display area where the protection member is formed, and therefore the strength of a portion corresponding to the non-display area in the lower substrate may be improved. Thus, according to embodiments, the OLED display may be made slim by reducing the entire thickness of the OLED display and impact resistance may be improved by improving the strength of the lower substrate.

[0064] Example embodiments have been disclosed herein, and although specific terms are employed, they are used and are to be interpreted in a generic and descriptive sense only and not for purpose of limitation. In some instances, as would be apparent to one of ordinary skill in the art as of the filing of the present application, features, characteristics, and/or elements described in connection with a particular embodiment may be used singly or in combination with features, characteristics, and/or elements described in connection with other embodiments unless otherwise specifically indicated. Accordingly, it will be understood by those of skill in the art that various changes in form and details may be made without departing from the spirit and scope of the present invention as set forth in the following claims.

<Description of symbols>	
100, 200: OLED display	110, 210: lower substrate
120: protection member	130: upper substrate
140: polarizer	150: window
160: adhesive layer	170: main board
280: reinforcing member	H1: first thickness
H2: second thickness	H3: third thickness
H4: fourth thickness	

What is claimed is:

1. An organic light emitting diode (OLED) display, comprising:
- a lower substrate having a display area displaying an image and a non-display area formed along an edge of the display area, the display area having a first thickness, at

- least a part of the non-display area having a second thickness that is greater than the first thickness; and
 - a protection member disposed at the lower side of the lower substrate, the protection member being disposed in the display area of the lower substrate.
2. The OLED display of claim 1, wherein, in the lower side of the lower substrate, the lower substrate has an inclined or curved interface between a portion formed with the first thickness and a portion formed with the second thickness.
3. The OLED display of claim 2, wherein one end of the protection member is adjacent to a portion where the inclination or the curve starts in the interface.
4. The OLED display of claim 1, wherein the protection member has a size that is equal to or smaller than the display area of the lower substrate.
5. The OLED display of claim 1, wherein the protection member has a third thickness, and the sum of the first thickness and the third thickness is equal to or greater than the second thickness.
6. An organic light emitting diode (OLED) display, comprising:
- a window;
 - a lower substrate disposed at a lower side of the window, and including a display area and a non-display area;
 - a protection member disposed in the display area of the lower substrate; and
 - a reinforcement member disposed in the shape of a plate and disposed at a lower side of the lower substrate, the reinforcement member supporting a portion of the lower substrate that corresponds to the non-display area.
7. The OLED display of claim 6, wherein the protection member has a size that is equal to or smaller than the display area of the lower substrate.
8. The OLED display of claim 6, wherein the protection member has a third thickness, the reinforcement member has a fourth thickness, and the third thickness is equal to or greater than the fourth thickness.
9. The OLED display of claim 6, wherein the reinforcement member is made of an aluminum alloy or stainless steel.
10. The OLED display of claim 6, wherein the reinforcement member is extended to support the lower side of the window.

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专利名称(译)	有机发光二极管显示器		
公开(公告)号	US20140252944A1	公开(公告)日	2014-09-11
申请号	US13/956672	申请日	2013-08-01
[标]申请(专利权)人(译)	李相熙 金焕金		
申请(专利权)人(译)	LEE , SANG-HEE KIM , HWAN-JIN		
当前申请(专利权)人(译)	LEE , SANG-HEE KIM , HWAN-JIN		
[标]发明人	LEE SANG HEE KIM HWAN JIN		
发明人	LEE, SANG-HEE KIM, HWAN-JIN		
IPC分类号	H05B33/12		
CPC分类号	H05B33/12 H01L51/5096 H01L2251/558 H01L27/3225 H01L27/3244 H01L51/5253 H01L27/32 H01L51/56		
优先权	1020130024699 2013-03-07 KR		
其他公开文献	US9024522		
外部链接	Espacenet USPTO		

摘要(译)

有机发光二极管 (OLED) 显示器包括下基板, 该下基板具有显示图像的显示区域和沿显示区域的边缘形成的非显示区域, 该显示区域具有第一厚度, 至少一部分非显示区域 - 具有第二厚度大于第一厚度的显示区域; 保护构件设置在下基板的下侧, 保护构件设置在下基板的显示区域中。

